Electronic Patent Application Fee Transmittal							
Application Number:	10	10825335					
Filing Date:	16-	16-Apr-2004					
Title of Invention:	Su	Substrate support jig, circuit board production apparatus, and method of producing circuit board					
First Named Inventor/Applicant Name:	Ta	Tatsuki Nogiwa					
Filer:	Ke	Kenneth Wayne Fields/Karen Gass					
Attorney Docket Number:	20	2004-0601A					
Filed as Large Entity							
Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:					1		
Pages:				Α			
Claims:			16				
Claims in excess of 20		1202	1	50	50		
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)				
Miscellaneous:								
Request for continued examination	1801	1	810	810				
	Total in USD (\$)			860				